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COMPACT, FLEXIBLE, LED ARRAY

5 CROSS-REFERENCE TO RELATED APPLICATION(S)

The present application is a continuation-in-part of co-pending U.S. Patent Application Serial No. 09/258,057, filed February 26, 1999, the entire disclosure of which is expressly incorporated herein by reference.

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FIELD OF THE INVENTION

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The present invention relates generally to lighting systems and, more particularly, to flexible, compact, battery operated LED arrays that are able to be conformably mounted over surfaces with compound curvatures.

BACKGROUND OF THE INVENTION

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Light emitting diode (LED) lighting systems are commonly used as individual elements or in groups for illuminating a large variety of objects. Typically, such lighting systems are arranged in generally linear rows and are disposed so as to provide decorative, advertising or safety oriented light sources. Conventionally, these lighting system rows might be attached to a wire string such as exemplified by a "string of lights" used for Christmas tree decorations. Lighting systems constructed of LED light strips, are particularly advantageous when compared to bulb or lamp based lighting systems in that light strips are relatively inexpensive to manufacture and consume a relatively small amount of power. However, conventional lighting systems, whether bulb based or LED based are limited in usefulness due to the difficulty of attaching them to various structures and that these types of lighting systems are often inflexible in their design and require permanent mounting to attached structures.

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Present LED light strips typically composed of circuitry including a number of LEDs mounted onto substrates by having

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their whisker leads soldered onto connection points provided for such purpose and connected to electrical conductors. The entire
5 circuitry is typically encased within a protective sheathing and coupled to a power source for selective LED illumination. Such LED lighting systems are utilized in a variety of indoor and outdoor configurations, but suffer from significant drawbacks in that the LED lamps are rather large, are exposed to the elements
10 and are very susceptible to damage by wind, water, etc. Additionally, these LED lighting systems require that the LED lamps be adhered to a mounting substrate by having their whisker leads soldered thereto. Once the LED lamp is affixed to the substrate, excess lead material must be removed and the resulting
15 assembly mounted on a support that is substantially flat in order that the viewing angle for the component LED lamps is not exceeded.

Conventional LED based lighting systems typically utilize dual-lead cannister or dome shaped LED lamps as a light source.
20 These dome or cannister shaped LED lamps are typically about 5 to 7 millimeters tall and from about 3 to about 5 millimeters in diameter, exclusive of their electrically conductive leads. Although available in various colors, a typical conventional LED lamp will have a light intensity (expressed in millicandles or
25 mcd) of from about 8 to about 50, when implemented in Gallium Phosphide (GaP) with a viewing angle of approximately 10 to 15 degrees. Needless to say, when such lighting systems are mounted over radiused or other conformal surfaces, it requires very little displacement to move the beam angle of a particular LED
30 lamp outside the viewing arc.

For example, LED lighting systems have been used in the prior art as auxiliary brake lights in automotive applications. Five millimeter LEDs are typically used to supplement original equipment vehicle brake lights and incorporated onto a mounting
35 surface which is adhered or secured to the rear portion of a

vehicle. Considerable differences in angles of inclination and curvatures of rear window glasses and other vehicular surfaces limit the usefulness of such LED lighting systems. For example, when an auxiliary brake light is mounted on a vehicle provided with a rear window glass having a strong curvature, an optimum mounting or viewing angle for each LED lamp may not be achieved. For this reason, a single type of auxiliary light, capable of being placed on various portions of all manners of vehicles, is very difficult to economically manufacture.

In addition, many conventional 5 millimeter LED lighting systems have their LED lamps spaced-apart from one another to such an extent that the individual component light sources are easily discernable. In other words, instead of a viewer perceiving a lighting system having uniform brightness, the viewer perceives intermittent bright spots, corresponding to LED light source positions, over the surface area of the lighting system. Various prior art systems have attempted to address this problem by placing distortion lenses (or diffusion lenses) over the LED light sources, but these distortion lenses are not altogether effective and further tend to reduce the overall brightness of the lighting system. Conventional 5 millimeter LEDs, even if disposed as close together as possible, still exhibit inconsistent light distribution due to their relatively shallow viewing angles. Prior art lighting systems are thus relatively large, visually unpleasing and relatively expensive and time consuming to manufacture. Thus, in addition to exhibiting relatively poor performance, their size and shape tend to make them objectionably obtrusive.

Accordingly, what is needed is a flexible, low-profile, bright, easily manufactured and visually pleasing light emitting diode system which can be mounted easily, in any desired form over radically radiused compound curvatures, for a variety of uses. Further, such a light emitting diode system needs to

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provide a constant source of light while operated by a relatively low voltage battery source.

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SUMMARY OF THE INVENTION

10 A flexible, low profile, high density array of light emitting diodes includes a plurality of surface mount light emitting diodes affixed to the surface of a flexible printed circuit board substrate, the substrate adapted to support and electrically interconnect surface mount electronic components. Each of the plurality of surface mount light emitting diodes has a particular dimension, less than or equal to about 3mm, and is disposed on the flexible printed circuit board substrate at
15 varying distances in order to define light intensity outputs of from about 2 to about 20 candles per square centimeter.

20 The flexible printed circuit board substrate might be configured as a flex circuit, or might be configured as a rigid flex circuit board, each pre-manufactured to define mounting locations for each of the plurality of surface mount light emitting diodes. The flexible printed circuit board substrate, in combination with the surface mount light emitting diodes, defines a conformable, bendable lighting array configured for mounting upon surfaces with compound curvature.

25 The surface mount light emitting diodes are configured, upon the flexible substrate, in an array comprising regular sets of series-connected diodes, the series-connected sets coupled in parallel fashion to one another. The number of light emitting diodes comprising a series-connected set defines a forward
30 voltage drop for the set. The forward voltage drop, in turn, defines a supply voltage value sufficient to activate the diodes of each series-connected set. Surface mount diodes comprising the array might have forward voltage drops anywhere in the range of from about 1.7 to about 5.0 volts.

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In a further aspect of the invention, the flexible, low profile, high density lighting system further includes a housing configured to hold and support a flexible lighting array and so encloses the array as to protect it from impact and the elements. The housing might be transparent and might further be colored. Alternatively, the housing might be water clear and the plurality of surface mount light emitting diodes might be colored.

DESCRIPTION OF THE DRAWINGS

These and other features, aspects and advantages of the present invention will be more fully understood when considered with respect to the following detailed description, appended claims and accompanying drawings, wherein:

FIG. 1 is a top planar view of a high-density, low-profile, flexible light emitting diode array in accordance with the present invention;

FIG. 2 is a side elevation view of the high-density, low-profile, flexible light emitting diode array in accordance with the present invention;

FIG. 3 is a top planar view of one embodiment of a housing for use with the light emitting diode array in accordance with the invention;

FIG. 4 is an end view of the exemplary housing embodiment of FIG. 3, illustrating a lighting element within;

FIG. 5 is a perspective view of the exemplary embodiment of the housing of FIG. 3;

FIG. 6a is a side elevation view of one embodiment of a surface mount light emitting diode suitable for use in connection with the diode array of the present invention;

FIG. 6b is an end view of the surface mount light emitting diode of FIG. 6a;

FIG. 6c is a top planar view of the surface mount light emitting diode of FIG. 6a;

FIG. 7a is a side elevation view of an alternative embodiment of a surface mount light emitting diode suitable for use in connection with the diode array of the present invention;

FIG. 7b is an end view of the surface mount light emitting diode of FIG. 7a;

FIG. 7c is a top planar view of the surface mount light emitting diode of FIG. 7a;

FIG. 8 is a simplified, semi-schematic illustration of a surface mount light emitting diode being surface mounted on an exemplary flexible substrate;

FIG. 9 is a simplified, semi-schematic circuit diagram illustrating the electrical connectivity of the surface mount LEDs, resistive elements and power source, in accordance with the present invention;

FIG. 10a is a simplified top planar view of an alternative array embodiment, where the light emitting diodes are disposed on a planar area sheet substrate; and

FIG. 10b is a simplified top planar view of a further alternative array embodiment, where the light emitting diodes are disposed along a cursive substrate.

DETAILED DESCRIPTION OF THE INVENTION

Briefly, the present invention is directed to a high-density, low-profile, flexible light emitting diode array which is constructed to have an extremely narrow width and an extremely low profile and have its elements so disposed that the length of the array is able to vary in accordance with any desired application. In typical embodiments, an array length might vary from about a few inches to several feet, and the array itself can be adaptively configured to a desired length by merely cutting the desired length from a roll, as will be described in greater detail below.

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5 The high-density, low-profile, flexible light emitting diode array is very compact and elegant which enables it to be used for a number of sophisticated interior applications, such as volume or accent highlighting, architectural and landscaping delineation, and the like. Additionally, the high-density, low-profile, flexible light emitting diode array is able to deliver a very high light output (light intensity) per unit volume, which enables the light emitting diode array to be used for various industrial, safety and other exterior utility applications, such as vehicle lighting systems, marker lights, building safety lamps, and the like. Flexibility is a further advantageous feature of the light emitting diode array which is configured such that it is able to be flexed or bent into extremely compound or complex shapes including those with a very small radius of curvature. When a flexible strip of the light emitting array is affixed to an interior rear window or ceiling of an automobile, for example, as an auxiliary brake light, the extremely thin and narrow profile of the array does not substantially block a driver's vision nor does it substantially intrude into the limited interior space of the passenger compartment of the vehicle.

25 With a very high light intensity per unit volume, the light emitting diode array is particularly advantageous when used in building safety systems that provide emergency lighting when central power is cut off. The light emitting diode array is configured to be battery operated such that it is not susceptible to AC power outages and provides sufficient light output to clearly mark emergency exits, stairs, emergency signage, and the like. Because of the adaptability of its size and shape, the light emitting diode array can be easily conformed to any size space to provide such battery powered illumination; with small strips providing sufficient illumination for relatively small

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areas, and larger strips, or alternatively planar sheets, disposed within large areas.

5 In addition to its high light output, another desirable aspect of the light emitting diode array is its unique and captivating appearance, which when activated resembles a bright, focused laser beam spanning the lighting system's length, from end-to-end. This laser beam look provides an eye catching safety
10 feature which compliments the efficacy of the light emitting diode array when used for safety applications, and further provides a well-defined and modern look to the light-emitting diode array when used in other applications such as decorative and space-lighting installations. It can easily be understood
15 that the array might be formed into strips that define alphanumeric text, which can be easily read from a distance. Thus, the array might easily be formed into safety side-panel strips (and emitting amber light) for example, for placement onto the exterior side panels of vehicles and for emergency or
20 informative road signage.

Referring more particularly to the drawings, FIGs. 1 and 2 illustrate a high-density, low-profile light emitting diode array constructed with an extremely compact configuration and having a very high density of light emitting elements disposed thereon.
25 The array 20 is depicted in the exemplary embodiment of FIGs. 1 and 2 in a particular configuration only for purposes of description and ease of understanding, and not for the purpose of limiting the invention to any extent.

In particular, the array 20 of the exemplary embodiment of
30 FIGs. 1 and 2, is suitably constructed from a plurality of light emitting diode elements 32 disposed in close proximity to one another and mounted on a flexible substrate 37, in accordance with the present invention. In the exemplary embodiment of FIGs. 1 and 2, the light emitting diode elements are disposed on the
35 flexible substrate 37 at positions approximately 2mm on centers,

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such that the center of each LED element is approximately 2mm from the center of an adjacent LED element or elements. In this particular exemplary embodiment, the LED elements 32 are in physical contact with one another and, as will be described in greater detail below, such proximity causes each element's resulting beam to overlap with the beam from adjacent elements in order to define a uniform light field.

Each of the light emitting diode elements 32 are surface mounted to a flexible substrate, in particular, a class A or class B flex circuit board, as defined by MIL-STD-2118. Class A flex circuits are defined as those capable of withstanding flexing during installation, while class B flex circuits are defined as those capable of withstanding continuous flexing for a specified number of cycles after the flex circuit has been installed.

Because flex circuits will typically be bent during assembly and may be flexed continually during use, certain circuit features must be designed with sufficient strain relief. These particular circuit features are well understood and need not be dealt with here, but it should be noted that depending on its application, the light emitting diode array when configured on a class B flex circuit should be constructed to be as thin as is practical and should further be symmetrical, such that its conductor layers are maintained as close as possible to the neutral axis.

The flex circuit material depends significantly upon the type and complexity of the light emitting diode array disposed thereon, but for most applications, a simple single layer or double layer plated through hole (PTH) flex circuit will be suitable. Polyimide is the most popular material for high reliability applications, but polyester film for the insulation layer is equally suitable. Adhesives might include polyester, acrylic or epoxy adhesives, with a polyester film and polyester

adhesive combination offering the greatest degree of flexibility at the lowest cost.

5 Rolled annealed copper is the most common conductor used for flexible printed circuits due to its superior flexing characteristics and high conductivity. Electro deposited copper is used in applications when its temper can be an asset, such as in applications requiring extremely fine cantilevered leads. 10 Notwithstanding the foregoing, flex circuits may be manufactured from other metals, such as beryllium copper, nickel and stainless steel, depending on the mounting or utility application of the light emitting diode array system 20.

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15 The primary function of flexible circuits is the interconnection of one electronic component to another and the method used to terminate the flexible interconnection is of particular concern. As will be described in greater detail below, the preferred LED element is a low-profile surface mount LED which is able to be mounted on a flexible circuit by a 20 variety of methods. In particular, flex circuits might terminate in through hole solder pads capable of accepting a connector or being soldered directly onto a component. Copper or copper alloy fingers can be soldered in place and secured within the circuit's insulation layer and can further be etched to any configuration 25 and be custom formed so as to accept any type of low-profile surface mount LED lead configuration. Exposed pads can be formed to provide a dimple pattern for use in pressure contact applications or shaped insulation openings can be provided for surface mount directly to the flex circuit. In the latter 30 attachment method, polyimide stiffeners can be bonded to the flex circuit in order rigidize the surface mount areas.

Although the substrate has been described as a flex circuit, it should be understood that it need not necessarily conform to the requirements of MIL-STD-2118 nor the technical requirements 35 necessary to be referred to as a "flex circuit". Indeed, the

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nanometers to about 660 nanometers. A lens 64 (dome shaped in the exemplary embodiment of FIGs. 6a-6c) is provided over the light emitting semiconductor material and might be a colored transparent lens, a colored diffusing lens, or a water clear lens, depending upon the final color and light output desired for each light emitting element. In particular, depending on lens type, the light emitting diode 63 of the exemplary embodiment has a light intensity I_v (expressed in millicandles or mcd at 20mA), ranging from about 200 to about 1000, evaluated at a nominal viewing angle of from approximately 30 degrees to approximately 60 degrees.

Surface mount bonding leads 66 are provided and project from both sides of the diode bulk in the length direction. One of the leads is electrically coupled to the anode side of the diode semiconductor material, while the other lead is electrically coupled to the cathode side. During assembly, each diode element is positioned onto a pre-manufactured, flexible substrate, configured to receive surface mount diodes, such that the mount leads contact exposed conductors, surface mount solder bumps, or bonding pads, as best illustrated in FIG. 8. Mounting areas are located in pre-defined regions on the flexible substrate material so that their positioning and periodicity can be easily programmed into automated pick-and-place equipment. The size, shape and bond lead locations of the diode elements are equally pre-defined and programmable such that the entire operation can be fully automated.

The diode element 63 of FIGs. 6a-6c is merely one embodiment of diode elements suitable for practice of the present invention. Since its beam is relatively directional, due to its 30 to 60 degree viewing angle, its perceived light intensity output makes it particularly suitable for applications which require the attention of a viewer to be drawn to the lighting system, i.e., vehicular lights, emergency signs, etc. Other types of surface

A particular such alternative diode element is illustrated in FIGs. 7a, 7b and 7c. FIGs. 7a-7c depict an extremely low-profile light emitting diode element 73, which is substantially smaller in cross-section than the embodiment of FIGs. 6a-6c. Diode element 73 has a width 75 of about 0.8mm, a height 77 of about 0.5mm, and a length 79 of about 1.6mm. Further, it should be understood that the height dimension will vary whether or not the diode element 73 is provided with a cover (or lens, indicated at 74). In the particular configuration illustrated in FIGs. 7a-7c, each light emitting diode would have a light intensity of from about 100 to about 300 millicandles (mcd), again at 25 mA, but evaluated at the optical axis of a viewing angle of about 120 degrees to about 150 degrees. Thus, while its specified light intensity is lower than the previous embodiment, its output is distributed across a wider dispersion angle, making this embodiment particularly suitable for wide area illumination applications.

The diode 73 also includes bonding leads 76, coupled to the semiconductor material's anode and cathode terminals, and which are conformally formed about the bottom edge of the bulk material so as to further reduce the diode's area footprint.

The light intensity ratio, in candles per unit length, may be varied by adjusting the spacing of the light emitting diodes along the length of the flexible substrate. The light ratio may be lower, on a per centimeter basis, if smaller diodes are substantially spaced-apart from one another, and may be much greater, on a per centimeter basis, if the slightly larger sized, lower dispersion angle, diodes are mounted closer together, or even in contact proximity with one another.

In accordance with the present invention, both the lengths and widths of the light emitting diode may vary widely, depending

on the application, but are generally selected to be within a range of from about 2mm to about 3mm. A particularly suitable set of surface mount light emitting diodes are the KP, KA, and KM, series of diodes manufactured and sold by Kingbright Corporation, City of Industry, California. These surface mount LEDs exhibit viewing angles of anywhere from about 15 to about 150 degrees, which allows a lighting system, constructed in accordance with the invention, to be tailored to specific desirable dispersion and viewing characteristics, when compared to various prior art devices.

Returning momentarily to FIGs. 1 and 2, the width dimension 72 of the particular high-density, low-profile light emitting diode array 20 illustrated in the exemplary embodiment, is approximately 0.25cm. Given an approximately 1.0cm long section of the lighting system, the total surface area can be seen to be approximately 0.25cm², which would host five surface mount LEDs as embodied in FIGs. 6a-6c. With each of the surface mount LED elements emitting approximately 1 candle of light, the light intensity output of the light emitting diode array 20 of the exemplary embodiment can be seen to be about 20 candles/cm². The present inventors believe this to be an extremely high, and indeed a previously unobserved, LED light intensity per unit area ratio.

Turning now to FIG. 9, there is depicted in simplified, semi-schematic form, an exemplary circuit diagram showing the electrical connectivity of the surface mount LED elements, resistive elements and power source, as they might be implemented on a typical flexible substrate (as shown in FIG. 8), in accordance with the present invention. As contemplated by the invention, a flexible printed circuit board (37 of FIG. 8) is double-sided, with the surface mount light emitting elements 91 connected to a front side (or facing side) with resistive elements 95 and electrical traces 96 disposed on the opposite

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however, can be contemplated which would allow for such extended periodicity, including safety lighting along the steps of a movie theater, for example. In these cases, lighting elements can be spaced as far apart as twelve inches or more if required.

In FIGs. 3-5, the housing 22 is illustrated as being completely transparent, but might suitably be provided with its transparency only in areas where it is desirable for light to be emitted. The entire housing 22 or portions thereof, might be configured to be clear without color, to provide a certain look, with the plurality of light emitting elements 32 being constructed to emit a certain color of light when activated. Alternatively, light emitting elements might be selected to emit a white light, with the housing being colored, in turn.

Figures 3, 4 and 5 illustrate a top planar, end and perspective view, respectively, of a typical housing 22 such as might be implemented in the context of the present invention. The housing of the illustrated embodiment is a flexible, hollow, D-channel tube having an adhesive backing strip 49 affixed to the flat back side of the housing 22. The adhesive backing strip 49 can be implemented with any suitable adhesive, and can be used in conjunction with or in place of screws or other mounting hardware for securing the light emitting element array 20 to any desired surface. Since the D-channel housing is flexible, it does not detract from the flexible, conformal nature of a light emitting element array. The backside of the housing might also include a magnetic strip in addition to or in place of the adhesive backing strip, or any other form of fastening means by which the housing and light emitting element array assembly might be affixed to a surface.

Once the housing is provided, the element array 20 is slid into the housing and the housing is sealed by suitable end caps. Two guide surfaces, or lips, 51 and 53 are formed in the housing 22 in order to define two slots which are suitable for

accommodating a flexible substrate 37. After the flexible substrate 37 is secured within the two slots of the housing, the end pieces and are secured into opposing ends 56 and 58 of the housing. An adhesive, preferably including sealant properties, is applied to a small diameter portion of each of the two end pieces. The small diameter portions of each of the two end pieces are subsequently inserted into the respective opposing ends 56 and 58 of the housing 22, such that the two end pieces are permanently secured to the housing. Once the end pieces are permanently secured, a watertight seal is created around the diode array and the array is thus protected from impact and the elements. Conductors for supplying power from an external power source extend through one or both of the end pieces, without disrupting the watertight seal, using conventional pass-through means.

It should be understood that even though the housing 22 is illustrated as a flexible, transparent, hollow D-channel tube, its profile properties are immaterial to practice of principles of the invention. In particular, where it is desirable to protect the diode array from the elements or from impact, any form of housing would be generally suitable. The housing might merely be a hemispherical cover having the appropriate flexibility and light transmission characteristics, or alternatively, the housing might have a square cross-section, rectangular cross-section, or any other shape that would tend to cover and protect the LED array. Indeed, in many applications, the array need not even be disposed within a housing.

It is contemplated that the high-density, low-profile, flexible light emitting diode array according to the exemplary embodiments of the present invention has application in a wide variety of environments. The following includes several of these contemplated applications, but is not intended to be either limiting or exhaustive. The array might have particular

application in a traffic control environment, such as providing directional sign outline lighting, smart sensor activated lighting for traffic control, temporary barrier demarcation, active road signs, and the like. The array of the present invention also has various automotive and other applications, such as aircraft interior compartment lighting, automotive running lights, trailer indicator lights, decorative paneling, side panel turn indicators, and the like.

As depicted in FIGs. 10a and 10b, the elements need not be disposed in a linear fashion. Various alternative arrangements can be defined for a lighting system, according to the invention, depending on the configuration of the underlying flexible substrate. Since the flexible substrate/diode element combination is solely surface mount, substrates can be prepared to take on any shape or curvature, and the diode elements easily disposed thereon after substrate preparation. Substrates might be arranged in a sheet, with multiple rows of elements, as in FIG. 10a, or in cursives, as in FIG. 10b. Any manufacturable shape of substrate will accommodate a compact, low-profile, high intensity LED lighting system according to the invention.

It should be appreciated that the light emitting diode array of the present invention is completely impervious to moisture ingress, when disposed within an appropriate housing, and may therefore be used in certain underwater applications such as for aquarium or pool lighting. It will be evident that when enclosed in an appropriate housing, it has particular utility in exterior applications that might be otherwise susceptible to inclement weather.

It should further be appreciated that use of such high-density, low-profile, flexible light emitting diode arrays result in substantial cost savings over current lighting system implementations. Since LEDs, by their nature, are non-filament type light sources, there is no need to be concerned with

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breakage or frequent replacement. Further, since the LED array structure according to the invention provides a substantial light intensity output using only a nominal 12 volt, or thereabouts, power supply, there is no need to locate the arrays in proximity to an AC power source, as is required with conventional lighting systems. Low voltage and low current operation ensures that LED lighting systems will exhibit an average lifetime approximately an order of magnitude higher than that of conventional filament based lighting systems, while consuming at least several orders of magnitude lower current, for an equal light intensity output.

Thus, although various exemplary embodiments of the invention have been illustrated and described, various changes, modifications and substitutions, in addition to those set forth in the preceding specification, may be made by those having ordinary skill in the art without departing from the spirit and scope of the present invention, which is limited only by the scope of the appended claims.